## Commercial Surface Mount Chips

## EXAMPLE: 08055A101J AT2A

| A | T | 2 | A |
| :---: | :---: | :---: | :---: |
|  |  |  |  |
| Failure | Terminations | Packaging | Special |
| Rate | T = Plated Ni | Available | Code |
| $\mathrm{A}=\mathrm{N} / \mathrm{A}$ | and Sn | 2 = 7" Reel | $\mathrm{A}=\mathrm{Std}$. |
| 4 = Automotive | 7 = Gold Plated | $4=13$ "Reel |  |
|  | $J=$ Tin/Lead | 7 = Bulk Cass. |  |
|  |  | 9 = Bulk |  |

Contact Factory For

| 0805 | 5 | A |
| :---: | :---: | :---: |
|  |  |  |
| Size | Voltage | Dielectric |
| (L" x W") | $4=4 \mathrm{~V}$ | A $=$ NP0(C0G) |
| 0201 | $6=6.3 \mathrm{~V}$ | $\mathrm{C}=\mathrm{X7R}$ |
| 0402 | $\mathrm{Z}=10 \mathrm{~V}$ | $\mathrm{D}=\mathrm{X} 5 \mathrm{R}$ |
| 0603 | $\mathrm{Y}=16 \mathrm{~V}$ | $\mathrm{G}=\mathrm{Y} 5 \mathrm{~V}$ |
| 0805 | $3=25 \mathrm{~V}$ | $\mathrm{U}=\mathrm{U}$ Series |
| 1206 | $\mathrm{D}=35 \mathrm{~V}$ | W = X6S |
| 1210 | $5=50 \mathrm{~V}$ | $\mathrm{Z}=\mathrm{X7S}$ |
| 1812 | $1=100 \mathrm{~V}$ |  |
| 1825 | $2=200 \mathrm{~V}$ |  |
| 2220 | $7=500 \mathrm{~V}$ |  |
| 2225 |  |  |


| Contact Factory for |  |
| :---: | :---: |
| Special Voltages |  |
| $F=63 \mathrm{~V}$ | $9=300 \mathrm{~V}$ |
| $*=75 \mathrm{~V}$ | $X=350 \mathrm{~V}$ |
| $E=150 \mathrm{~V}$ | $8=400 \mathrm{~V}$ |
| $\mathrm{~V}=250 \mathrm{~V}$ |  |


| 101 | J* |
| :---: | :---: |
|  |  |
| Capacitance | Tolerance |
| 2 Sig. Fig + | $\mathrm{B}= \pm .10 \mathrm{pF}$ |
| No. of Zeros | $\mathrm{C}= \pm .25 \mathrm{pF}$ |
| Examples: | $\mathrm{D}= \pm .50 \mathrm{pF}$ |
| $100=10 \mathrm{pF}$ | $\mathrm{F}= \pm 1 \%$ ( $\geq 10 \mathrm{pF}$ ) |
| $101=100 \mathrm{pF}$ | $\mathrm{G}= \pm 2 \%$ ( $\geq 10 \mathrm{pF}$ ) |
| $102=1000 \mathrm{pF}$ | J = $\pm 5 \%$ |
| $223=22000 \mathrm{pF}$ | $\mathrm{K}= \pm 10 \%$ |
| $224=220000 \mathrm{pF}$ | $\mathrm{M}= \pm 20 \%$ |
| $105=1 \mu \mathrm{~F}$ | $\mathrm{Z}=+80 \%,-20 \%$ |
| $106=10 \mu \mathrm{~F}$ | $\mathrm{P}=+100 \%,-0 \%$ |
| $107=100 \mu \mathrm{~F}$ |  |
| For values below |  |
| 10 pF , use "R" |  |
| in place of |  |
| Decimal point, e.g., $91 \mathrm{pF}=9 \mathrm{R} 1$ |  |

Contact Factory For 1 = Pd/Ag Term Z $=$ Soft Termination


|  | T |
| :---: | :---: |
|  |  |
| Failure Rate A = N/A 4 = Automotive | Terminations |
|  | T = Plated Ni |
|  | and Sn |
|  | 7 = Gold Plated |
|  | $\mathrm{J}=$ Tin/Lead |
|  | Contact |
|  | 1 = Pd/Ag Term |
|  | Z = Soft | each capacitance value.

* $B, C \& D$ tolerance for $\leq 10 \mathrm{pF}$ values.

Standard Tape and Reel material (Paper/Embossed) depends upon chip size and thickness.
See individual part tables for tape material type for

High Voltage Surface Mount Chips
EXAMPLE: 1808AA271KA11A

| 1808 | A | A | 271 | K | A | 1 | 1A |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | \| |  |  | I |  |  |
| AVX | Voltage | Temperature | Capacitance | Capacitance | Failure | Termination | Packaging/Marking |
| Style | $\mathrm{C}=600 \mathrm{~V}$ | Coefficient | Code | Tolerance | Rate | $1=\mathrm{Pd} / \mathrm{Ag}$ | $1 \mathrm{~A}=7{ }^{\text {r Reel }}$ |
| 1206 | $\mathrm{A}=1000 \mathrm{~V}$ | A $=$ COG | (2 significant digits | COG: J = $\pm 5 \%$ | A $=$ Not | T = Plated Ni | Unmarked |
| 1210 | $\mathrm{S}=1500 \mathrm{~V}$ | $\mathrm{C}=\mathrm{X} 7 \mathrm{R}$ | + no . of zeros) | $\mathrm{K}= \pm 10 \%$ | Applicable | and Sn | $3 \mathrm{~A}=13$ "Reel |
| 1808 | $\mathrm{G}=2000 \mathrm{~V}$ |  | Examples: | $\mathrm{M}= \pm 20 \%$ |  |  | Unmarked |
| 1812 | $\mathrm{W}=2500 \mathrm{~V}$ |  | $10 \mathrm{pF}=100$ | X7R: $K= \pm 10 \%$ |  |  | $9 \mathrm{~A}=\mathrm{Bulk} / \mathrm{Unmarked}$ |
| 1825 | $\mathrm{H}=3000 \mathrm{~V}$ |  | $100 \mathrm{pF}=101$ | $\mathrm{M}= \pm 20 \%$ |  |  |  |
| 2220 | $\mathrm{J}=4000 \mathrm{~V}$ |  | $1,000 \mathrm{pF}=102$ | $\mathrm{Z}=+80 \%$, |  |  |  |
| 2225 | $\mathrm{K}=5000 \mathrm{~V}$ |  | $2,000 \mathrm{pF}=223$ | -20\% |  |  |  |
| 3640 |  |  | $\begin{array}{r} 0,000 \mathrm{pF}=224 \\ 1 \mu \mathrm{~F}=105 \end{array}$ |  |  |  |  |

## Capacitor Array

EXAMPLE: W2A43C 103MAT2A


## Low Inductance C apacitors (LICC)

EXAMPLE: 0612ZD105MAT2A


## Interdigitated Capacitors (IDC)

## EXAMPLE: W3L16D225MAT3A



## Decoupling Capacitor Arrays (LICA)

EXAMPLE: LICA3T183M3FC4AA



COG (NPO) is the most popular formulation of the "tempera-ture-compensating," EIA Class I ceramic materials. Modern COG (NPO) formulations contain neodymium, samarium and other rare earth oxides.
COG (NPO) ceramics offer one of the most stable capacitor dielectrics available. Capacitance change with temperature is $0 \pm 30 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ which is less than $\pm 0.3 \% \Delta \mathrm{C}$ from $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Capacitance drift or hysteresis for COG (NP0) ceramics is negligible at less than $\pm 0.05 \%$ versus up to $\pm 2 \%$ for films. Typical capacitance change with life is less than $\pm 0.1 \%$ for COG (NPO), one-fifth that shown by most other dielectrics. COG (NPO) formulations show no aging characteristics.
The C0G (NPO) formulation usually has a "Q" in excess of 1000 and shows little capacitance or "Q" changes with frequency. Their dielectric absorption is typically less than $0.6 \%$ which is similar to mica and most films.

## PART NUMBER (see page 2 for complete part number explanation)





Variation of Impedance with Chip Size
Impedance vs. Frequency
1000 pF - C OG (NPO)


Insulation Resistance vs Temperature



